BT152-500RT SCR, 20 A, 32 mA, 500 V, SOT78 Rev. 01 — 12 May 2009

Product data sheet

Product profile 1.

1.1 General description

Planar passivated SCR (Silicon Controlled Rectifier) in a SOT78 plastic package

1.2 Features and benefits

- High reliability
- High temperature capable
- High thermal cycling performance
- Very high surge capability

1.3 Applications

- Ignition circuits
- Motor control

- Protection circuits
- Static switching

1.4 Quick reference data

Table 1. **Quick reference**

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V_{DRM}	repetitive peak off-state voltage		-	-	500	V
V_{RRM}	repetitive peak reverse voltage		-	-	500	V
$I_{T(AV)}$	average on-state current	half sine wave; T _{mb} ≤ 122 °C; see <u>Figure 3</u>	-	-	13	Α
I _{T(RMS)}	RMS on-state current	half sine wave; all conduction angles; see Figure 1; see Figure 2	-	-	20	Α
I _{TSM}	non-repetitive peak on-state current	half sine wave; $t_p = 8.3 \text{ ms}$; $T_{j(init)} = 25 \text{ °C}$	-	-	220	Α
		half sine wave; $t_p = 10 \text{ ms}$; $T_{j(init)} = 25 \text{ °C}$; see Figure 4; see Figure 5	-	-	200	Α
Static ch	aracteristics					
I _{GT}	gate trigger current	$V_D = 12 \text{ V; T}_j = 25 \text{ °C;}$ $I_T = 100 \text{ mA; see } \frac{\text{Figure 8}}{}$	-	3	32	mA



2. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K	cathode		N 1
2	Α	anode	mb	A
3	G	gate		G sym037
3 G mb A	A	mounting base; connected to anode	1 2 3	
			SOT78 (TO-220AB; SC-46)	

3. Ordering information

Table 3. Ordering information

Type number	Package				
	Name	Description	Version		
BT152-500RT	TO-220AB; SC-46	plastic single-ended package; heatsink mounted; 1 mounting hole; 3-lead TO-220AB	SOT78		

4. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{DRM}	repetitive peak off-state voltage		-	500	V
V_{RRM}	repetitive peak reverse voltage		-	500	V
$I_{T(AV)}$	average on-state current	half sine wave; T _{mb} ≤ 122 °C; see <u>Figure 3</u>	-	13	Α
I _{T(RMS)}	RMS on-state current	half sine wave; all conduction angles; see Figure 1; see Figure 2	-	20	Α
dI _T /dt	rate of rise of on-state current	$I_T = 50 \text{ A}$; $I_G = 200 \text{ mA}$; $dI_G/dt = 200 \text{ mA/}\mu\text{s}$	-	200	A/µs
I_{GM}	peak gate current		-	5	Α
P_{GM}	peak gate power		-	20	W
T _{stg}	storage temperature		-40	150	°C
Tj	junction temperature		-	150	°C

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
I _{TSM}	non-repetitive peak	half sine wave; $t_p = 8.3 \text{ ms}$; $T_{j(init)} = 25 \text{ °C}$	-	220	Α
	on-state current	half sine wave; $t_p = 10 \text{ ms}$; $T_{j(init)} = 25 \text{ °C}$; see Figure 4; see Figure 5	-	200	Α
l ² t	I ² t for fusing	t _p = 10 ms; sine-wave pulse	-	200	A^2s
$P_{G(AV)}$	average gate power	over any 20 ms period	-	1	W
V_{RGM}	peak reverse gate voltage		-	5	V

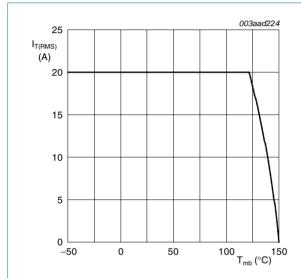
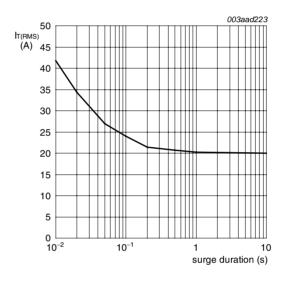
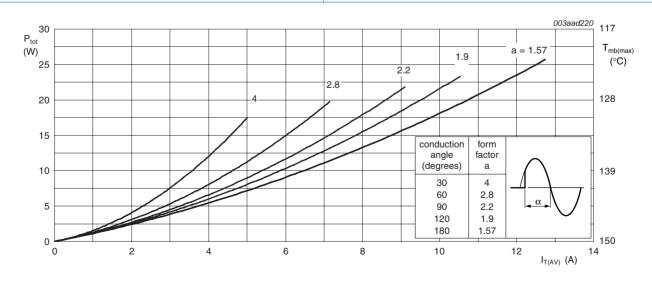


Fig 1. RMS on-state current as a function of mounting base temperature; maximum values



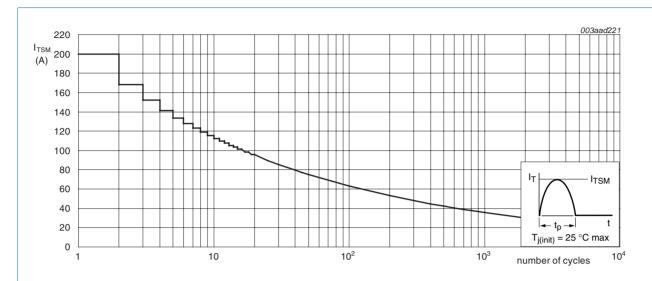
 $f = 50 \text{ Hz } T_{sp} = 122 \text{ }^{\circ}\text{C}$

Fig 2. RMS on-state current as a function of surge duration; maximum values



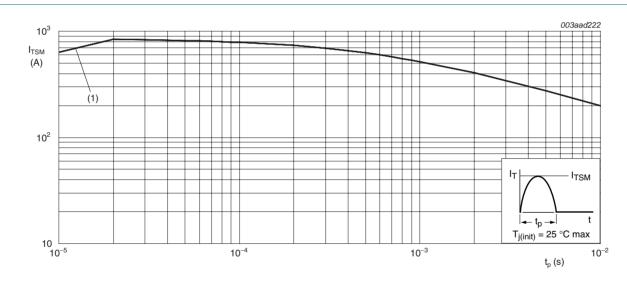
a =form factor $= I_{T(RMS)} / I_{T(AV)}$

Fig 3. Total power dissipation as a function of average on-state current; maximum values



 $f = 50 \,\mathrm{Hz}$

Fig 4. Non-repetitive peak on-state current as a function of the number of sinusoidal current cycles; maximum values



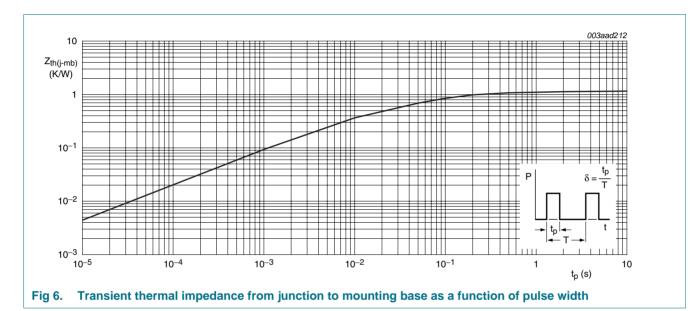
 $t_p \leq 10 \text{ ms}(1) \text{ d}I_T/\text{dt limit}$

Fig 5. Non-repetitive peak on-state current as a function of pulse width for sinusoidal currents; maximum values

5. Thermal characteristics

Table 5. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$R_{th(j\text{-}mb)}$	thermal resistance from junction to mounting base	see Figure 6	-	-	1.1	K/W
R _{th(j-a)}	thermal resistance from junction to ambient free air		-	60	-	K/W



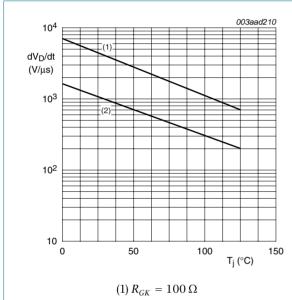
6. Characteristics

Table 6. Characteristics

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Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static cha	aracteristics					
I _{GT}	gate trigger current	$V_D = 12 \text{ V}; T_j = 25 \text{ °C}; I_T = 100 \text{ mA};$ see Figure 8	-	3	32	mA
IL	latching current	$V_D = 12 \text{ V; } T_j = 25 \text{ °C; } I_G = 100 \text{ mA;}$ see Figure 9	-	25	80	mA
l _H	holding current	T _j = 25 °C; see <u>Figure 10</u>	-	15	60	mΑ
V_{T}	on-state voltage	$I_T = 40 \text{ A}; T_j = 25 \text{ °C}; \text{ see } \frac{\text{Figure 11}}{\text{M}}$	-	1.4	1.75	V
V_{GT}	gate trigger voltage	$I_T = 100 \text{ mA}; V_D = 12 \text{ V}; T_j = 25 \text{ °C};$ see Figure 12	-	0.6	1.5	V
		$I_T = 100 \text{ mA}; V_D = 500 \text{ V}; T_j = 125 \text{ °C}$	0.25	0.4	-	V
I_D	off-state current	V _D = 500 V; T _j = 125 °C	-	0.2	1	mA
I_R	reverse current	$V_R = 500 \text{ V}; T_j = 125 ^{\circ}\text{C}$	-	0.2	1	mA

Table 6. Characteristics ... continued

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Dynamic	charateristics					
dV _D /dt	rate of rise of off-state voltage	V_{DM} = 335 V; T_j = 125 °C; gate open circuit; see Figure 7	200	300	-	V/µs
t _{gt}	gate-controlled turn-on time	I_{TM} = 40 A; V_D = 500 V; I_G = 100 mA; dI_G/dt = 5 A/ μ s	-	2	-	μs
tq	commutated turn-off time	$V_{DM} = 335 \text{ V; } T_j = 125 \text{ °C; } I_{TM} = 20 \text{ A;}$ $V_R = 25 \text{ V; } (dI_T/dt)_M = 30 \text{ A/µs;}$ $dV_D/dt = 50 \text{ V/µs; } R_{GK} = 100 \Omega$	-	70	-	μs



(2) Gate open circuit

Fig 7. Critical rate of rise of off-state voltage as a

function of junction temperature; typical values

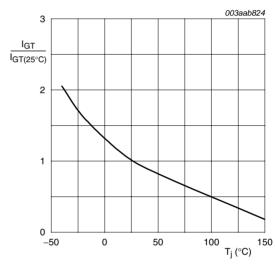


Fig 8. Normalized gate trigger current as a function of junction temperature

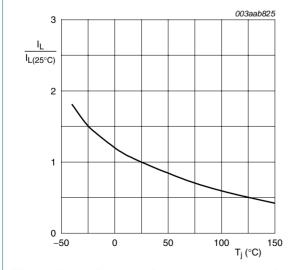


Fig 9. Normalized latching current as a function of junction temperature

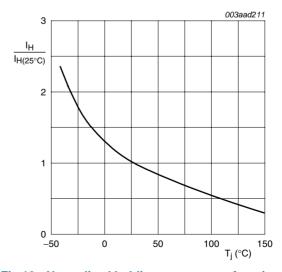
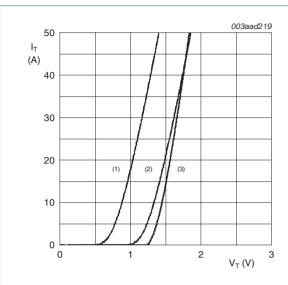


Fig 10. Normalized holding current as a function of junction temperature



 $V_o = 1.06 \text{ V}; R_s = 0.03 \Omega$

(1) $T_j = 150$ °C; typical values (2) $T_j = 150$ °C; maximum values

(3) $T_j = 25$ °C; maximum values

Fig 11. On-state current as a function of on-state voltage

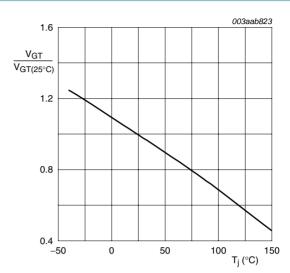


Fig 12. Normalized gate trigger voltage as a function of junction temperature

7. Package outline

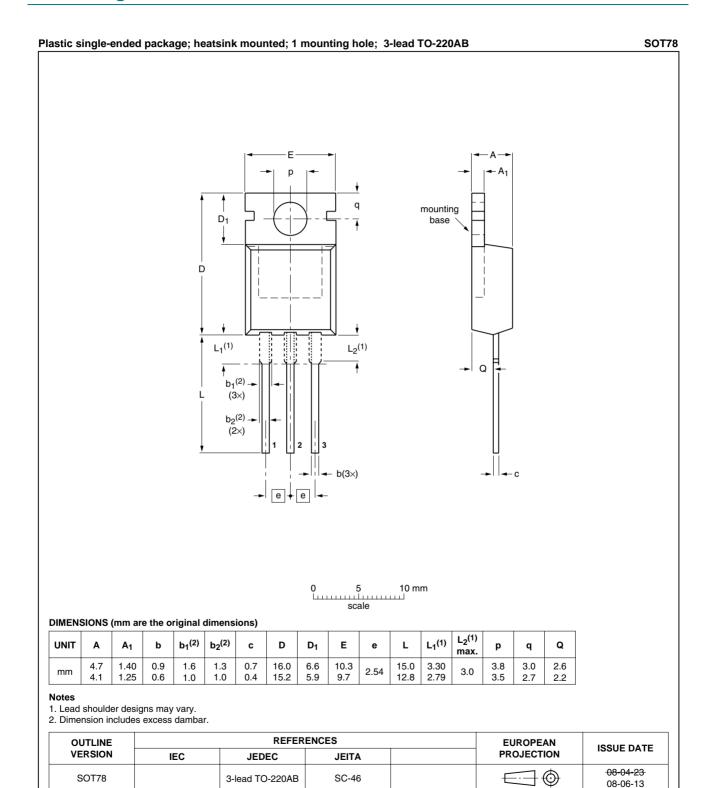


Fig 13. Package outline SOT78 (TO-220AB)

SCR, 20 A, 32 mA, 500 V, SOT78

8. Revision history

Table 7. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BT152-500RT_1	20090512	Product data sheet	-	-

9. Legal information

9.1 Data sheet status

Document status [1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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